

## **Dual Voltage Detector with Adjustable Hysteresis**

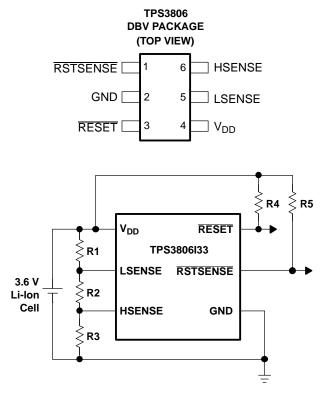
### **FEATURES**

- Dual Voltage Detector With Adjustable Hysteresis 3.3-V/Adjustable and 2-V/Adjustable
- Assured Reset at V<sub>DD</sub> = 0.8 V
- Supply Current: 3 μA Typical at V<sub>DD</sub> = 3.3 V
- Independent Open-Drain Reset Outputs
- Temperature Range: -40°C to +85°C
- 6-Pin SOT-23 Package

### **DESCRIPTION**

The TPS3806 integrates two independent voltage detectors for battery voltage monitoring. During power-on, RESET and RSTSENSE are asserted when supply voltage V<sub>DD</sub> or the voltage at LSENSE input become higher than 0.8 V. Thereafter, the supervisory circuit monitors VDD and LSENSE, keeping RESET and RSTSENSE active as long as V<sub>DD</sub> and LSENSE remain below the threshold voltage, V<sub>IT</sub>. As soon as  $V_{DD}$  or LSENSE rise above the threshold voltage  $V_{IT}$ , RESET or RSTSENSE is deasserted, respectively. The TPS3806 device has a fixed-sense threshold voltage VIT set by an internal voltage divider at V<sub>DD</sub> and an adjustable second-LSENSE input. In addition, an upper voltage threshold can be set at **HSENSE** to allow wide adjustable а hysteresis window.

The devices are available in a 6-pin SOT-23 package. The TPS3806 device is characterized for operation over a temperature range of -40°C to +85°C.



**Typical Operating Circuit** 



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





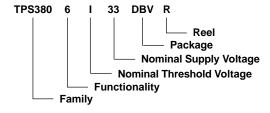
This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### ORDERING INFORMATION(1)

| т              | DEVICE                        | - NAME                        | THRESHOL        | D VOLTAGE | MARKING |
|----------------|-------------------------------|-------------------------------|-----------------|-----------|---------|
| I <sub>A</sub> | DEVICE                        | ENAME                         | V <sub>DD</sub> | SENSE     | WARKING |
| 40°C to 195°C  | TPS3806J20DBVR <sup>(2)</sup> | TPS3806J20DBVT <sup>(3)</sup> | 1.8 V           | 1.207 V   | PGQI    |
| -40°C to +85°C | TPS3806I33DBVR <sup>(2)</sup> | TPS3806I33DBVT <sup>(3)</sup> | 3 V             | 1.207 V   | PGPI    |

- (1) For the most current package and ordering information, see the Package Option Addendum located at the end of this data sheet or refer to our web site at www.ti.com.
- (2) The DBVR passive indicates tape and reel containing 3000 parts.
- (3) The DBVT passive indicates tape and reel containing 250 parts.



### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)(1)

|   | TPS3806J20, TPS3806I33       | UNIT |
|---|------------------------------|------|
| Supply voltage, V <sub>DD</sub> <sup>(2)</sup>  | 7                            | V    |
| All other pins <sup>(2)</sup>   | -0.3 to 7                    | V    |
| Maximum low-output current, I <sub>OL</sub>   | 5                            | mA   |
| Maximum high-output current, I <sub>OH</sub>  | -5                           | mA   |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>DD</sub> )  | ±10                          | mA   |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>DD</sub> ) | ±10                          | mA   |
| Continuous total power dissipation  | See Dissipation Rating Table |      |
| Operating free-air temperature range, T <sub>A</sub>  | -40 to +85                   | °C   |
| Storage temperature range, T <sub>stg</sub>   | -65 to +150                  | °C   |
| Soldering temperature   | +260                         | °C   |

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### **DISSIPATION RATING TABLE**

| PACKAGE | T <sub>A</sub> < 25°C | DERATING FACTOR<br>ABOVE T <sub>A</sub> = 25°C | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 85°C<br>POWER RATING |
|---------|-----------------------|--|---------------------------------------|---------------------------------------|
| DBV     | 437 mW                | 3.5 mW/°C                                      | 280 mW                                | 227 mW                                |

<sup>(2)</sup> All voltage values are with respect to GND. For reliable operation, the device must not be continuously operated at 7 V for more than t = 1000 h.



### **RECOMMENDED OPERATING CONDITIONS**

|  | MIN | MAX                   | UNIT |
|--|-----|-----------------------|------|
| Supply voltage, V <sub>DD</sub>                      | 1.3 | 6                     | ٧    |
| Input voltage, V <sub>I</sub>                        | 0   | V <sub>DD</sub> + 0.3 | ٧    |
| Operating free-air temperature range, T <sub>A</sub> | -40 | +85                   | °C   |

### **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       |   |   | TEST CONDITIONS                                      | MIN   | TYP   | MAX   | UNIT   |
|-----------------|---|---|--|-------|-------|-------|--------|
|                 |   |   | V <sub>DD</sub> = 1.5 V, I <sub>OL</sub> = 1 mA      |       |       |       |        |
| $V_{OL}$        | Low-level output voltage  |   | $V_{DD} = 3.3 \text{ V}, I_{OL} = 2 \text{ mA}$      |       |       | 0.3   | V      |
|                 |   | V <sub>DD</sub> = 6 V, I <sub>OL</sub> = 3 mA |  |       |       |       |        |
|                 | Power-up reset voltage <sup>(1)</sup>                                 |   | $V_{DD} \ge 0.8 \text{ V}, I_{OL} = 50  \mu\text{A}$ |       |       | 0.2   | V      |
|                 |   | LSENSE  |  | 1.198 | 1.207 | 1.216 |        |
|                 | V <sub>IT</sub> Negative-going input threshold voltage <sup>(2)</sup> | TPS3806J20                                    | $T_A = +25^{\circ}C$                                 | 1.787 | 1.8   | 1.813 | V      |
|                 |   | TPS3806I33                                    |  | 2.978 | 3.0   | 3.022 |        |
|                 |   | LSENSE  |  | 1.188 | 1.207 | 1.226 |        |
| $V_{\text{IT}}$ |   | TPS3806J20                                    | $T_A = 0$ °C to +70°C                                | 1.772 | 1.8   | 1.828 | V<br>V |
|                 |   | TPS3806I33                                    |  | 2.952 | 3.0   | 3.048 |        |
|                 |   | LSENSE  |  | 1.183 | 1.207 | 1.231 |        |
|                 |   | TPS3806J20                                    | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$        | 1.764 | 1.8   | 1.836 |        |
|                 |   | TPS3806l33                                    |  | 2.94  | 3.0   | 3.06  |        |
| \/              | Lhyotoropio   | ·   | 1.2 V < V <sub>IT</sub> < 2.5 V                      |       | 60    |       | mV     |
| $V_{hys}$       | Hysteresis  |   | 2.5 V < V <sub>IT</sub> < 3.5 V                      |       | 90    |       | IIIV   |
| I               | Input current   | LSENSE, HSENSE                                |  | -25   |       | 25    | nA     |
| $I_{OH}$        | High-level output current   |   | $V_{DD} = V_{IT} + 0.2 \text{ V}, V_{OH} = V_{DD}$   |       |       | 300   | nA     |
|                 | I <sub>DD</sub> Supply current  |   | V <sub>DD</sub> = 3.3 V, Output unconnected          |       | 3     | 5     |        |
| IDD             |   |   | V <sub>DD</sub> = 6 V, Output unconnected            |       | 4     | 6     | μΑ     |
| Ci              | Input capacitance   |   | V <sub>I</sub> = 0 V to V <sub>DD</sub>              |       | 1     |       | pF     |

### **SWITCHING CHARACTERISTICS**

at R<sub>L</sub> = 1 M $\Omega$ , C<sub>L</sub> = 50 pF, T<sub>A</sub> = -40°C to +85°C

| PARA                      | METER                     | TEST CONDITIONS                | MIN                           | TYP | MAX | UNIT |    |
|---------------------------|---------------------------|--------------------------------|-------------------------------|-----|-----|------|----|
| Propagation (delay) time, |                           | V <sub>DD</sub> to RESET delay |                               |     | E   | 100  |    |
| <sup>l</sup> PHL          | high-to-low-level output  | LSENSE to RSTSENSE delay       | $V_{IH} = 1.05 \times V_{IT}$ |     | 5   | 100  | μs |
|                           | Propagation (delay) time, | V <sub>DD</sub> to RESET delay | $V_{IL} = 0.95 \times V_{IT}$ |     | -   | 100  |    |
| <sup>L</sup> PLH          | low-to-high-level output  | HSENSE to RSTSENSE delay       |                               |     | Э   | 100  | μs |

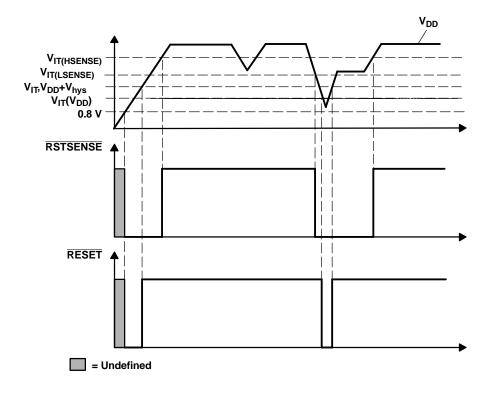
### **TIMING REQUIREMENTS**

at R<sub>L</sub> = 1 M $\Omega$ , C<sub>L</sub> = 50 pF, T<sub>A</sub> = -40°C to +85°C

| PARA           | PARAMETER   |                    | TEST CONDITIONS  | MIN | TYP | MAX | UNIT |
|----------------|-------------|--------------------|--|-----|-----|-----|------|
|                | Pulse width | At V <sub>DD</sub> | V - 105 x V V - 0.05 x V                                   | E   |     |     |      |
| ι <sub>w</sub> | Fuise width | At SENSE           | $V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$ | 5.5 |     |     | μs   |

 <sup>(1)</sup> The lowest supply voltage at which RESET becomes active. t<sub>r,VDD</sub> ≥ 15 μs/V
 (2) To ensure best stability of the threshold voltage, place a bypass capacitor (ceramic, 0.1 μF) near the supply terminals.





**Table 1. TERMINAL FUNCTIONS** 

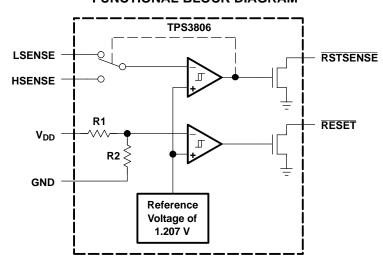
| TERMINAL I/O |   | 1/0 | DESCRIPTION  |
|--------------|---|-----|--|
|              |   | 1/0 | DESCRIPTION  |
| GND          | 2 | I   | Ground   |
| HSENSE 6 I   |   | I   | Adjustable hysteresis input                                |
| LSENSE       | 5 | I   | Adjustable sense input                                     |
| RESET        | 3 | 0   | Active-low open drain reset output (from V <sub>DD</sub> ) |
| RSTSENSE     | 1 | 0   | Active-low open-drain reset output (from LSENSE)           |
| $V_{DD}$     | 4 | I   | Input supply voltage and fixed sense input                 |

## **FUNCTION/TRUTH TABLE**

| TPS3806                                     |   |   |   |  |  |  |  |  |  |  |
|---|---|---|---|--|--|--|--|--|--|--|
| VDD > VIT   RESET   LSENSE > VIT   RSTSENSE |   |   |   |  |  |  |  |  |  |  |
| 0   | L | 0 | L |  |  |  |  |  |  |  |
| 1   | Н | 1 | Н |  |  |  |  |  |  |  |



### **FUNCTIONAL BLOCK DIAGRAM**



### **Detailed Description**

### Operation

The TPS3806 is used for monitoring battery voltage and asserting  $\overline{\text{RESET}}$  when a battery gets discharged below a certain threshold voltage. The battery voltage is monitored by a comparator via an external resistor divider. When the voltage at the LSENSE input drops below the internal reference voltage the  $\overline{\text{RSTSENSE}}$  output pulls low. The output remains low until the battery is replaced, or recharged above a second higher trip-point, set at HSENSE. A second voltage can be monitored at  $V_{DD}$ . The independent  $\overline{\text{RESET}}$  output pulls low when the voltage at  $V_{DD}$  drops below the fixed threshold voltage. Because the TPS3806 outputs are open-drain MOSFETs, most applications may require a pull-up resistor.

### **Programming the Threshold Voltage Levels**

The low-voltage threshold at LSENSE is calculated according to Equation 1:

$$V_{(LSENSE)} = V_{ref} \left( \frac{R1 + R2 + R3}{R2 + R3} \right)$$
(1)

where  $V_{ref} = 1.207 \text{ V}$ 

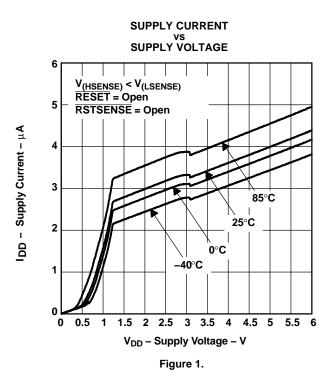
The high-voltage threshold at HSENSE is calculated as shown in Equation 2:

$$V_{(HSENSE)} = V_{ref} \left( \frac{R1 + R2 + R3}{R3} \right)$$
 (2)

where  $V_{ref} = 1.207 \text{ V}$ 

To minimize battery current draw it is recommended to use 1-M $\Omega$  as the total resistor value  $R_{(tot)}$ , with  $R_{(tot)} = R1 + R2 + R3$ .

### TYPICAL CHARACTERISTICS



# LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

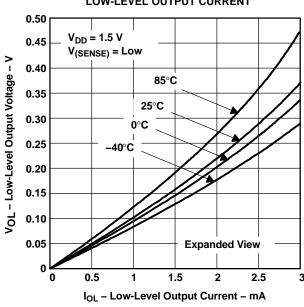
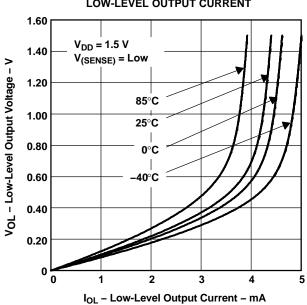


Figure 3.

# LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT



# LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

Figure 2.

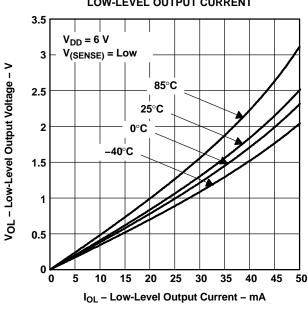


Figure 4.



## **TYPICAL CHARACTERISTICS (continued)**

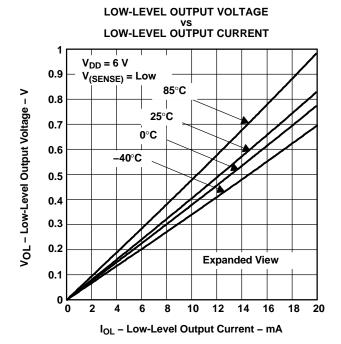
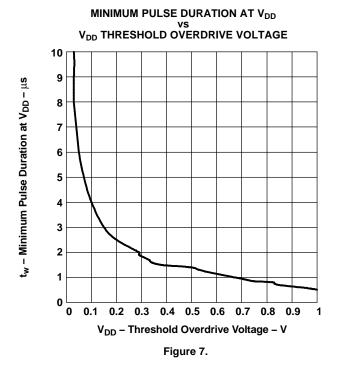


Figure 5.



## NORMALIZED INPUT THRESHOLD VOLTAGE vs FREE-AIR TEMPERATURE AT VDD

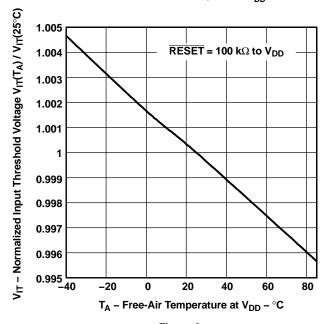
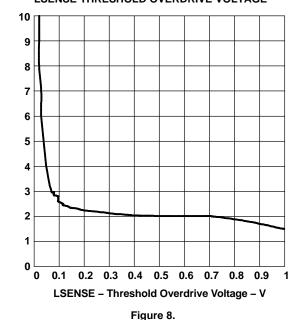


Figure 6.

## MINIMUM PULSE DURATION AT LSENSE VS LSENSE THRESHOLD OVERDRIVE VOLTAGE



 $t_w$  – Minimum Pulse Duration at LSENSE –  $\mu s$ 

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### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins   | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|------------------|-----------------------|------|-------------------------------|----------------------------|--------------|--------------|
|                       | (1)    | (2)           |                  |                       | (3)  | (4)                           | (5)                        |              | (0)          |
| TPS3806l33DBVR        | Active | Production    | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGPI         |
| TPS3806I33DBVR.B      | Active | Production    | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGPI         |
| TPS3806I33DBVR1G4     | Active | Production    | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGPI         |
| TPS3806I33DBVR1G4.B   | Active | Production    | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGPI         |
| TPS3806I33DBVT        | Active | Production    | SOT-23 (DBV)   6 | 250   SMALL T&R       | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGPI         |
| TPS3806I33DBVT.B      | Active | Production    | SOT-23 (DBV)   6 | 250   SMALL T&R       | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGPI         |
| TPS3806J20DBVR        | Active | Production    | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGQI         |
| TPS3806J20DBVR.B      | Active | Production    | SOT-23 (DBV)   6 | 3000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGQI         |
| TPS3806J20DBVT        | Active | Production    | SOT-23 (DBV)   6 | 250   SMALL T&R       | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGQI         |
| TPS3806J20DBVT.B      | Active | Production    | SOT-23 (DBV)   6 | 250   SMALL T&R       | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | PGQI         |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



## PACKAGE OPTION ADDENDUM

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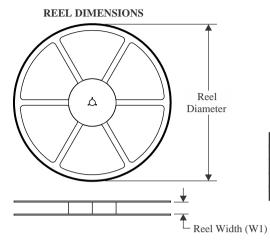
and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION



## 

|    | -   |
|----|---|
| A0 | Dimension designed to accommodate the component width     |
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

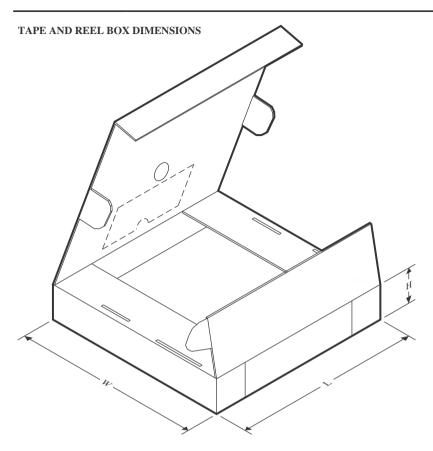


### \*All dimensions are nominal

| Device            | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS3806I33DBVR    | SOT-23          | DBV                | 6 | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3806l33DBVR1G4 | SOT-23          | DBV                | 6 | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3806I33DBVT    | SOT-23          | DBV                | 6 | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3806I33DBVT    | SOT-23          | DBV                | 6 | 250  | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3806J20DBVR    | SOT-23          | DBV                | 6 | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3806J20DBVT    | SOT-23          | DBV                | 6 | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |



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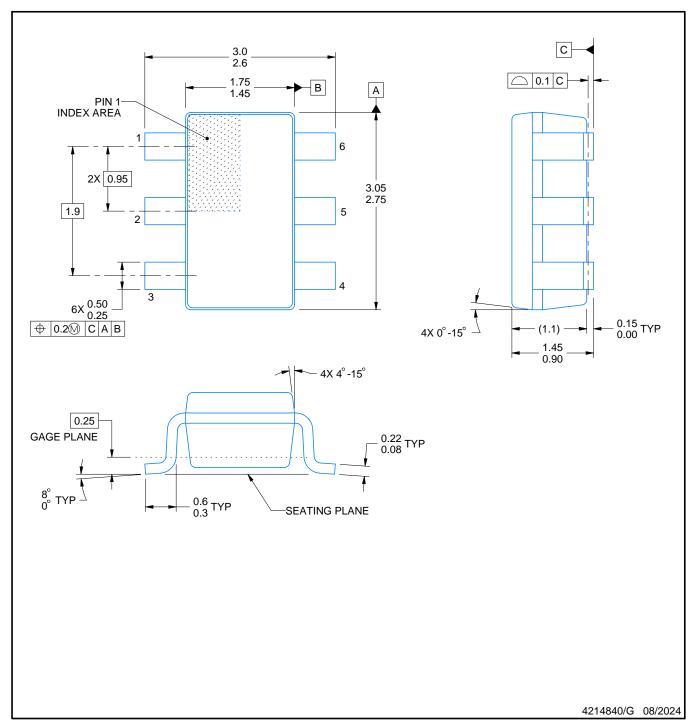


### \*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS3806I33DBVR    | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3806l33DBVR1G4 | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3806I33DBVT    | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3806I33DBVT    | SOT-23       | DBV             | 6    | 250  | 200.0       | 183.0      | 25.0        |
| TPS3806J20DBVR    | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3806J20DBVT    | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |



SMALL OUTLINE TRANSISTOR



### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

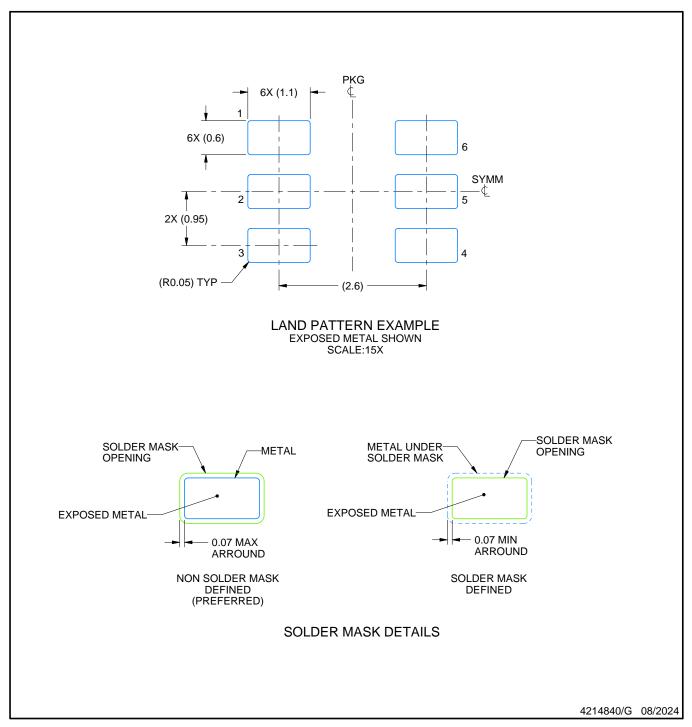
  2. This drawing is subject to change without notice.

  3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.

- 4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- 5. Refernce JEDEC MO-178.



SMALL OUTLINE TRANSISTOR



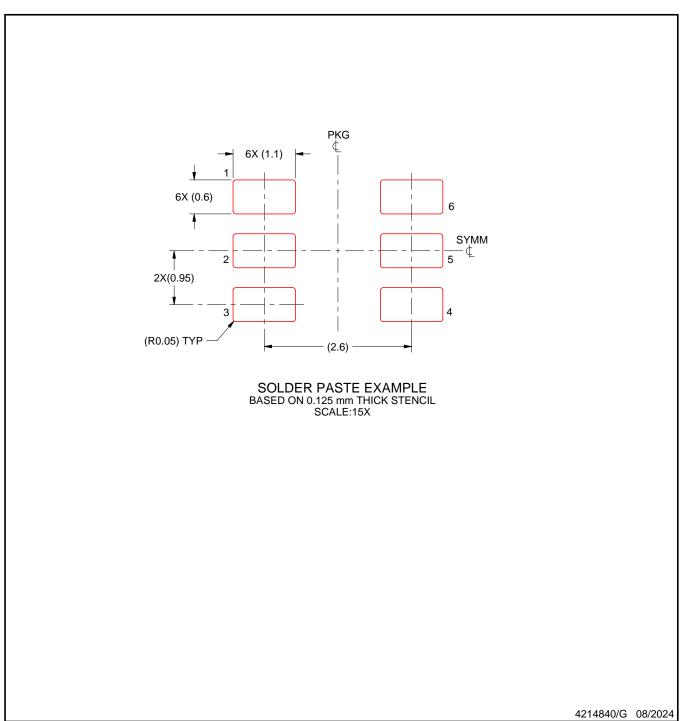
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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